#### Test point for surface mounting

## **HK-7** series

- This test point is for chip mounter use.
- This can also be used for pattern heat dissipation.
- This is tall and suitable when the parts nearby are tall.
- This is stored in an embossed tape.
- In the case of reflow with normal cream solder, the strength will be increased by using the land shape size of 2.5 × 2.5 or over.
- Material: Brass
- Finish

HK-7-G: Gold plating over nickel base HK-7-S: Tin plating over nickel base



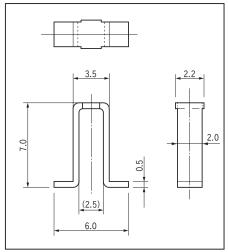
# ■ Part No.

Part No.	Package
HK-7-G-T	Reel (500pcs/reel)
HK-7-G	Bulk (100pcs/pack)
HK-7-S-T	Reel (500pcs/reel)
HK-7-S	Bulk (100pcs/pack)

### ■ Example of usage



#### **■** Dimension



#### ■ Recommended land information

